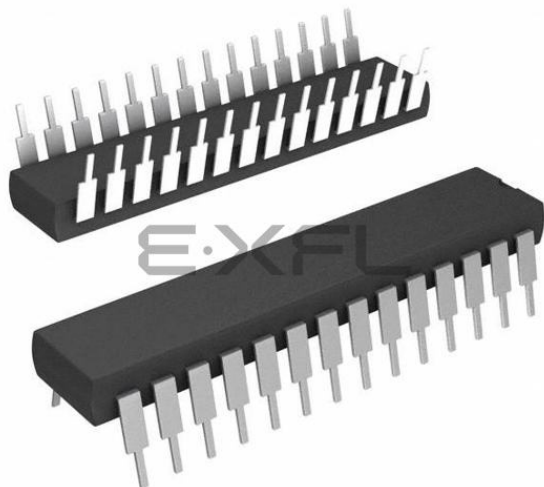




Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	352 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f916-i-sp

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, Accuron, dsPIC, KEELOQ, KEELOQ logo, microID, MPLAB, PIC, PICmicro, PICSTART, PRO MATE, PowerSmart, rfPIC, and SmartShunt are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AmPLab, FilterLab, Linear Active Thermistor, Migratable Memory, MXDEV, MXLAB, PS logo, SEEVAL, SmartSensor and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, ECAN, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, PICkit, PICDEM, PICDEM.net, PICLAB, PICtail, PowerCal, PowerInfo, PowerMate, PowerTool, REAL ICE, rFLAB, rfPICDEM, Select Mode, Smart Serial, SmartTel, Total Endurance, UNI/O, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2007, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
== ISO/TS 16949:2002 ==

PIC16F913/914/916/917/946

TABLE 6: PIC16F946 64-PIN (TQFP) SUMMARY

I/O	Pin	A/D	LCD	Comparators	Timers	CCP	AUSART	SSP	Interrupt	Pull-Up	Basic
RA0	27	AN0	SEG12	C1-	—	—	—	—	—	—	—
RA1	28	AN1	SEG7	C2-	—	—	—	—	—	—	—
RA2	29	AN2/VREF-	COM2	C2+	—	—	—	—	—	—	—
RA3	30	AN3/VREF+	SEG15	C1+	—	—	—	—	—	—	—
RA4	31	—	SEG4	C1OUT	T0CKI	—	—	—	—	—	—
RA5	32	AN4	—	C2OUT	—	—	—	$\overline{SS}$	—	—	—
RA6	40	SEG5	—	—	T1OSO	—	—	—	—	—	OSC2/CLKOUT
RA7	39	—	—	—	T1OSI	—	—	—	—	—	OSC1/CLKIN
RB0	15	—	SEG0	—	—	—	—	—	INT	Y	—
RB1	16	—	SEG1	—	—	—	—	—	—	Y	—
RB2	17	—	SEG2	—	—	—	—	—	—	Y	—
RB3	18	—	SEG3	—	—	—	—	—	—	Y	—
RB4	21	—	COM0	—	—	—	—	—	IOC	Y	—
RB5	22	—	COM1	—	—	—	—	—	IOC	Y	—
RB6	23	—	SEG14	—	—	—	—	—	IOC	Y	ICSPCLK/ICDCK
RB7	24	—	SEG13	—	—	—	—	—	IOC	Y	ICSPDAT/ICDDAT
RC0	49	—	VLCD1	—	—	—	—	—	—	—	—
RC1	50	—	VLCD2	—	—	—	—	—	—	—	—
RC2	51	—	VLCD3	—	—	—	—	—	—	—	—
RC3	52	—	SEG6	—	—	—	—	—	—	—	—
RC4	59	—	SEG11	—	$\overline{T1G}$	—	—	SDO	—	—	—
RC5	60	—	SEG10	—	T1CKI	CCP1	—	—	—	—	—
RC6	61	—	SEG9	—	—	—	TX/CK	SCK/SCL	—	—	—
RC7	62	—	SEG8	—	—	—	RX/DT	SDI/SDA	—	—	—
RD0	53	—	COM3	—	—	—	—	—	—	—	—
RD1	54	—	—	—	—	—	—	—	—	—	—
RD2	55	—	—	—	—	CCP2	—	—	—	—	—
RD3	58	—	SEG16	—	—	—	—	—	—	—	—
RD4	63	—	SEG17	—	—	—	—	—	—	—	—
RD5	64	—	SEG18	—	—	—	—	—	—	—	—
RD6	1	—	SEG19	—	—	—	—	—	—	—	—
RD7	2	—	SEG20	—	—	—	—	—	—	—	—
RE0	33	AN5	SEG21	—	—	—	—	—	—	—	—
RE1	34	AN6	SEG22	—	—	—	—	—	—	—	—
RE2	35	AN7	SEG23	—	—	—	—	—	—	—	—
RE3	36	—	—	—	—	—	—	—	—	Y ⁽¹⁾	$\overline{MCLR}/V_{PP}$
RE4	37	—	SEG24	—	—	—	—	—	—	—	—
RE5	42	—	SEG25	—	—	—	—	—	—	—	—
RE6	43	—	SEG26	—	—	—	—	—	—	—	—
RE7	44	—	SEG27	—	—	—	—	—	—	—	—
RF0	11	—	SEG32	—	—	—	—	—	—	—	—
RF1	12	—	SEG33	—	—	—	—	—	—	—	—
RF2	13	—	SEG34	—	—	—	—	—	—	—	—

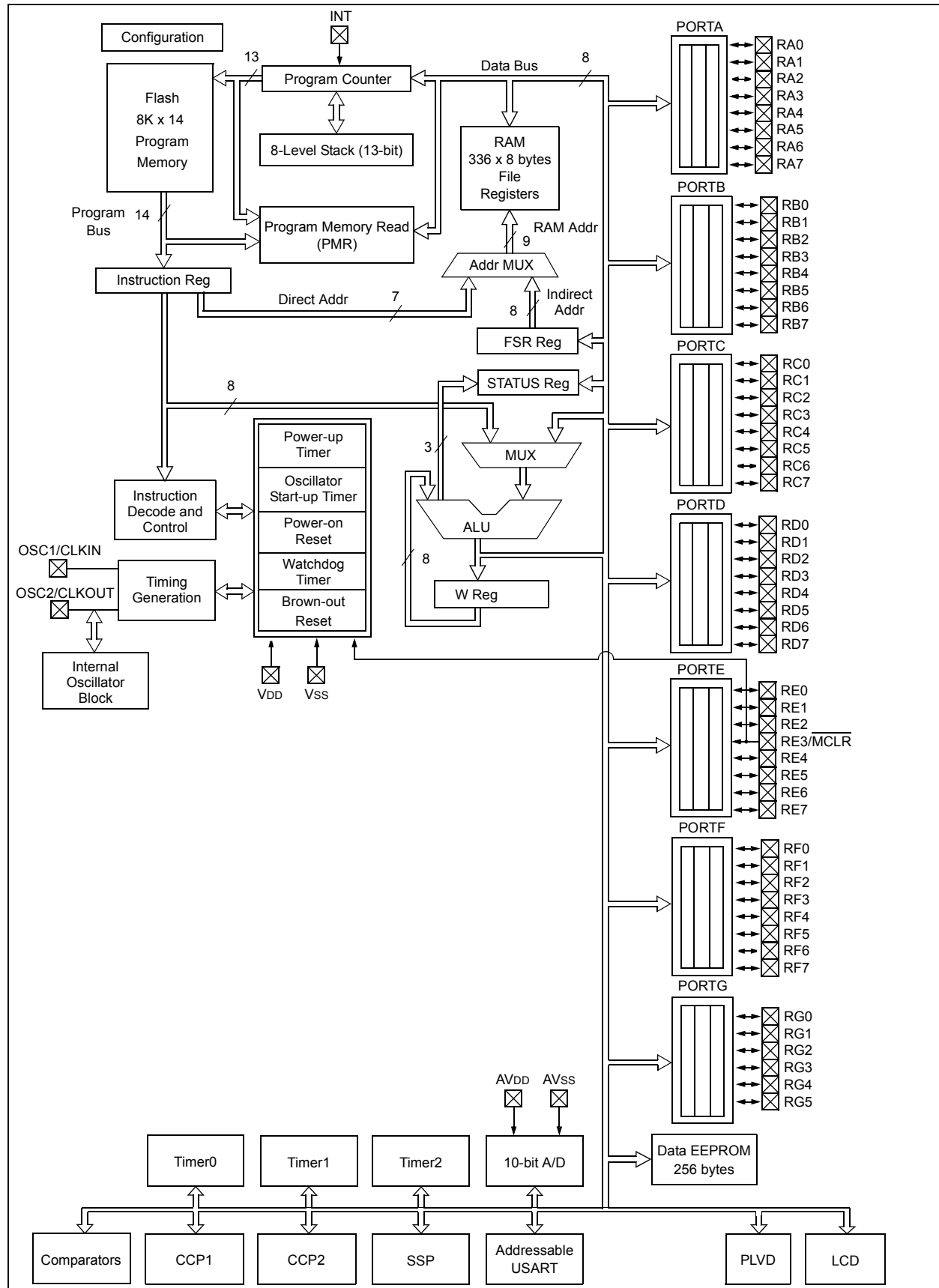
Note 1: Pull-up enabled only with external $\overline{MCLR}$ configuration.

PIC16F913/914/916/917/946

NOTES:

PIC16F913/914/916/917/946

FIGURE 1-3: PIC16F946 BLOCK DIAGRAM



3.0 I/O PORTS

The PIC16F913/914/916/917/946 family of devices includes several 8-bit PORT registers along with their corresponding TRIS registers and one four bit port:

- PORTA and TRISA
- PORTB and TRISB
- PORTC and TRISC
- PORTD and TRISD⁽¹⁾
- PORTE and TRISE
- PORTF and TRISF⁽²⁾
- PORTG and TRISG⁽²⁾

Note 1: PIC16F914/917 and PIC16F946 only.

2: PIC16F946 only

PORTA, PORTB, PORTC and RE3/MCLR/VPP are implemented on all devices. PORTD and RE<2:0> (PORTE) are implemented only on the PIC16F914/917 and PIC16F946. RE<7:4> (PORTE), PORTF and PORTG are implemented only on the PIC16F946.

REGISTER 3-1: ANSEL: ANALOG SELECT REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANS7 ⁽²⁾	ANS6 ⁽²⁾	ANS5 ⁽²⁾	ANS4	ANS3	ANS2	ANS1	ANS0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

ANS<7:0>: Analog Select bits

Analog select between analog or digital function on pins AN<7:0>, respectively.

1 = Analog input. Pin is assigned as analog input⁽¹⁾.

0 = Digital I/O. Pin is assigned to port or special function.

Note 1: Setting a pin to an analog input automatically disables the digital input circuitry, weak pull-ups, and interrupt-on-change if available. The corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

2: PIC16F914/PIC16F917/PIC16F946 only.

3.1 ANSEL Register

The ANSEL register (Register 3-1) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSEL bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSEL bits has no affect on digital output functions. A pin with TRIS clear and ANSEL set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

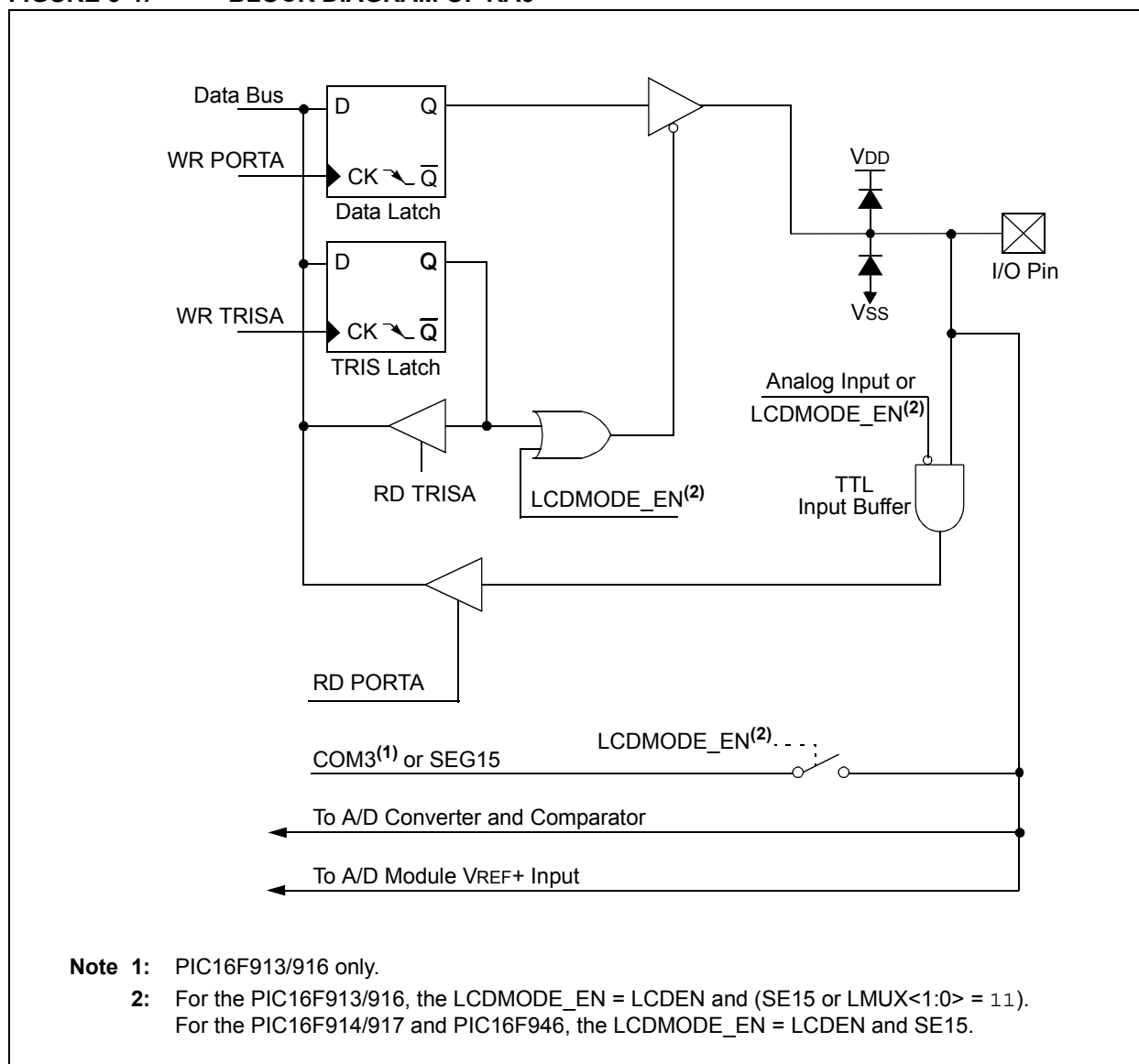
PIC16F913/914/916/917/946

3.2.1.4 RA3/AN3/C1+/VREF+/COM3/SEG15

Figure 3-4 shows the diagram for this pin. The RA3 pin is configurable to function as one of the following:

- a general purpose input
- an analog input for the ADC
- an analog input from Comparator C1
- a voltage reference input for the ADC
- analog outputs for the LCD

FIGURE 3-4: BLOCK DIAGRAM OF RA3



PIC16F913/914/916/917/946

REGISTER 3-7: WPUB: WEAK PULL-UP REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

WPUB<7:0>: Weak Pull-up Register bits

1 = Pull-up enabled

0 = Pull-up disabled

Note 1: Global $\overline{\text{RBPU}}$ must be enabled for individual pull-ups to be enabled.

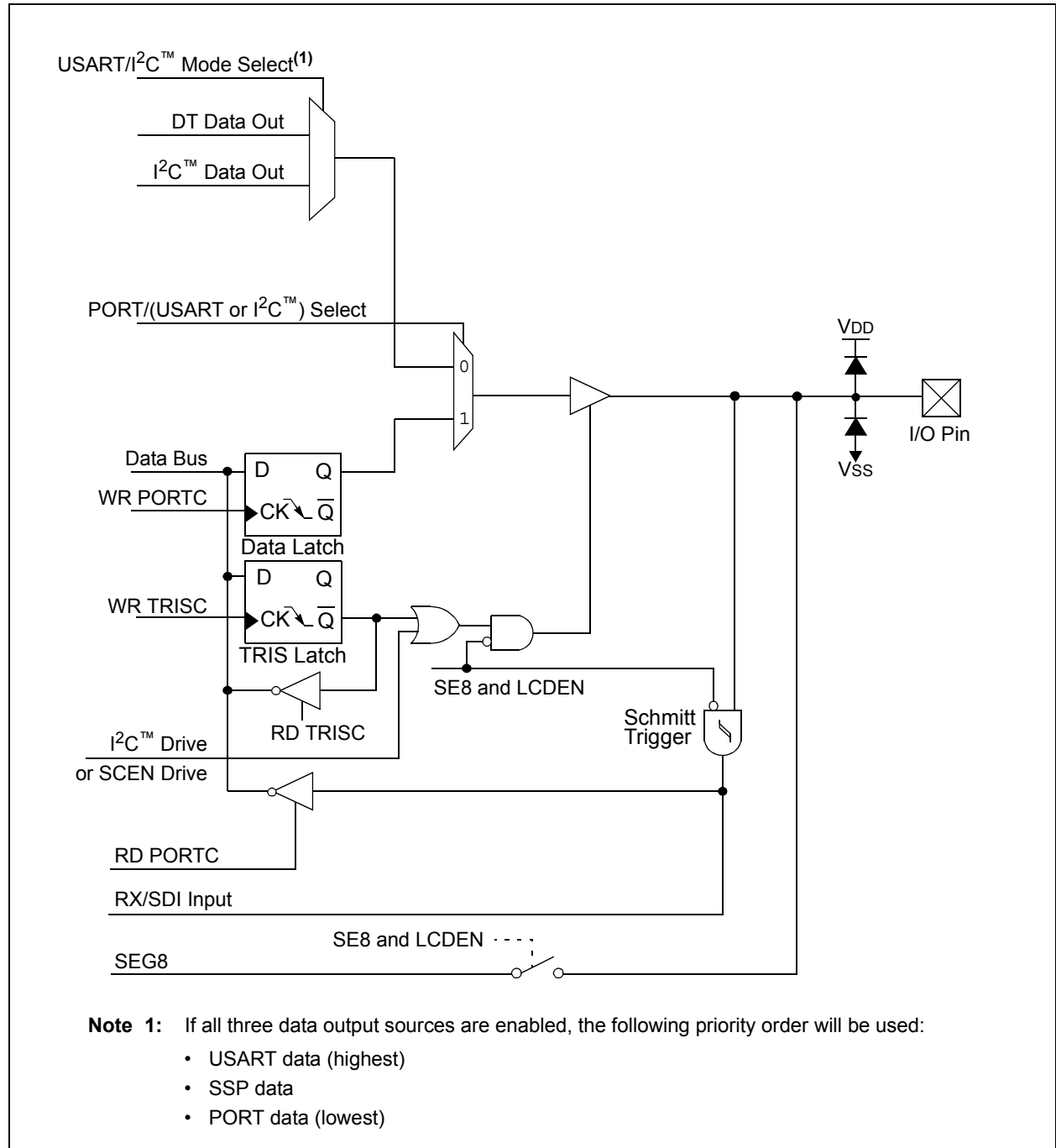
2: The weak pull-up device is automatically disabled if the pin is in Output mode ($\text{TRISx}<7:0> = 0$).

3.5.1.8 RC7/RX/DT/SDI/SDA/SEG8

Figure 3-21 shows the diagram for this pin. The RC7 pin is configurable to function as one of the following:

- a general purpose I/O
- an asynchronous serial input
- a synchronous serial data I/O
- a SPI data input
- an I²C data I/O
- an analog output for the LCD

FIGURE 3-21: BLOCK DIAGRAM OF RC7



PIC16F913/914/916/917/946

TABLE 3-3: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	--00 0000
LCDCON	LCDEN	SLPEN	WERR	VLCDEN	CS1	CS0	LMUX1	LMUX0	0001 0011	0001 0011
LCDSE0	SE7	SE6	SE5	SE4	SE3	SE2	SE1	SE0	0000 0000	uuuu uuuu
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE9	SE8	0000 0000	uuuu uuuu
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	0000 0000	uuuu uuuu
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTC.

PIC16F913/914/916/917/946

3.9 PORTG and TRISG Registers

PORTG is an 8-bit port with Schmitt Trigger input buffers. RG<5:0> are individually configured as inputs or outputs, depending on the state of the port direction. The port bits are also multiplexed with LCD segment functions. PORTG is available on the PIC16F946 only.

EXAMPLE 3-7: INITIALIZING PORTG

```
BANKSEL PORTG      ;  
CLRF   PORTG       ;Init PORTG  
BANKSEL TRISG      ;  
MOVLW  3Fh         ;Set RG<5:0> as inputs  
MOVWF  TRISG       ;
```

REGISTER 3-16: PORTG: PORTG REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	RG5	RG4	RG3	RG2	RG1	RG0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RG<5:0>:** PORTG I/O Pin bits

1 = Port pin is >V_{IH} min.

0 = Port pin is <V_{IL} max.

Note 1: PIC16F946 only.

REGISTER 3-17: TRISG: PORTG TRI-STATE REGISTER⁽¹⁾

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TRISG5	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **TRISF<5:0>:** PORTG Tri-State Control bits

1 = PORTG pin configured as an input (tri-stated)

0 = PORTG pin configured as an output

Note 1: PIC16F946 only.

8.8 Comparator C2 Gating Timer1

This feature can be used to time the duration or interval of analog events. Clearing the T1GSS bit of the CMCON1 register will enable Timer1 to increment based on the output of Comparator C2. This requires that Timer1 is on and gating is enabled. See **Section 6.0 “Timer1 Module with Gate Control”** for details.

It is recommended to synchronize Comparator C2 with Timer1 by setting the C2SYNC bit when the comparator is used as the Timer1 gate source. This ensures Timer1 does not miss an increment if the comparator changes during an increment.

8.9 Synchronizing Comparator C2 Output to Timer1

The output of Comparator C2 can be synchronized with Timer1 by setting the C2SYNC bit of the CMCON1 register. When enabled, the comparator output is latched on the falling edge of the Timer1 clock source. If a prescaler is used with Timer1, the comparator output is latched after the prescaling function. To prevent a race condition, the comparator output is latched on the falling edge of the Timer1 clock source and Timer1 increments on the rising edge of its clock source. Reference the comparator block diagrams (Figure 8-2 and Figure 8-3) and the Timer1 Block Diagram (Figure 6-1) for more information.

REGISTER 8-2: CMCON1: COMPARATOR CONFIGURATION REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0
—	—	—	—	—	—	T1GSS	C2SYNC
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **T1GSS:** Timer1 Gate Source Select bit⁽¹⁾

1 = Timer1 gate source is $\overline{T1G}$ pin (pin should be configured as digital input)

0 = Timer1 gate source is Comparator C2 output

bit 0 **C2SYNC:** Comparator C2 Output Synchronization bit⁽²⁾

1 = Output is synchronized with falling edge of Timer1 clock

0 = Output is asynchronous

Note 1: Refer to **Section 6.6 “Timer1 Gate”**.

2: Refer to Figure 8-3.

PIC16F913/914/916/917/946

TABLE 9-2: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000x
LCDCON	LCDEN	SLPEN	WERR	VLCDEN	CS1	CS0	LMUX1	LMUX0	0001 0011	0001 0011
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE9	SE8	0000 0000	0000 0000
PIE1	EEIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
PIR1	EEIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
RCREG	AUSART Receive Data Register								0000 0000	0000 0000
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
SPBRG	BRG7	BRG6	BRG5	BRG4	BRG3	BRG2	BRG1	BRG0	0000 0000	0000 0000
SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	1111 1111
TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010

Legend: x = unknown, - = unimplemented read as '0'. Shaded cells are not used for Asynchronous Reception.

PIC16F913/914/916/917/946

NOTES:

PIC16F913/914/916/917/946

16.3 Interrupts

The PIC16F91X/946 has multiple sources of interrupt:

- External Interrupt RB0/INT/SEG0
- TMR0 Overflow Interrupt
- PORTB Change Interrupts
- 2 Comparator Interrupts
- A/D Interrupt
- Timer1 Overflow Interrupt
- EEPROM Data Write Interrupt
- Fail-Safe Clock Monitor Interrupt
- LCD Interrupt
- PLVD Interrupt
- USART Receive and Transmit interrupts
- CCP1 and CCP2 Interrupts
- Timer2 Interrupt

The Interrupt Control (INTCON), Peripheral Interrupt Request 1 (PIR1) and Peripheral Interrupt Request 2 (PIR2) registers record individual interrupt requests in flag bits. The INTCON register also has individual and global interrupt enable bits.

A Global Interrupt Enable bit, GIE of the INTCON register, enables (if set) all unmasked interrupts, or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in the INTCON, PIE1 and PIE2 registers. GIE is cleared on Reset.

The Return from Interrupt instruction, `RETFIE`, exits the interrupt routine, as well as sets the GIE bit, which re-enables unmasked interrupts.

The following interrupt flags are contained in the INTCON register:

- INT Pin Interrupt
- PORTB Change Interrupt
- TMR0 Overflow Interrupt

The peripheral interrupt flags are contained in the special registers, PIR1 and PIR2. The corresponding interrupt enable bit are contained in the special registers, PIE1 and PIE2.

The following interrupt flags are contained in the PIR1 register:

- EEPROM Data Write Interrupt
- A/D Interrupt
- USART Receive and Transmit Interrupts
- Timer1 Overflow Interrupt
- CCP1 Interrupt
- SSP Interrupt
- Timer2 Interrupt

The following interrupt flags are contained in the PIR2 register:

- Fail-Safe Clock Monitor Interrupt
- Comparator 1 and 2 Interrupts
- LCD Interrupt
- PLVD Interrupt
- CCP2 Interrupt

When an interrupt is serviced:

- The GIE is cleared to disable any further interrupt.
- The return address is pushed onto the stack.
- The PC is loaded with 0004h.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends upon when the interrupt event occurs (see Figure 16-8). The latency is the same for one or two-cycle instructions. Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid multiple interrupt requests.

Note 1: Individual interrupt flag bits are set, regardless of the status of their corresponding mask bit or the GIE bit.

2: When an instruction that clears the GIE bit is executed, any interrupts that were pending for execution in the next cycle are ignored. The interrupts, which were ignored, are still pending to be serviced when the GIE bit is set again.

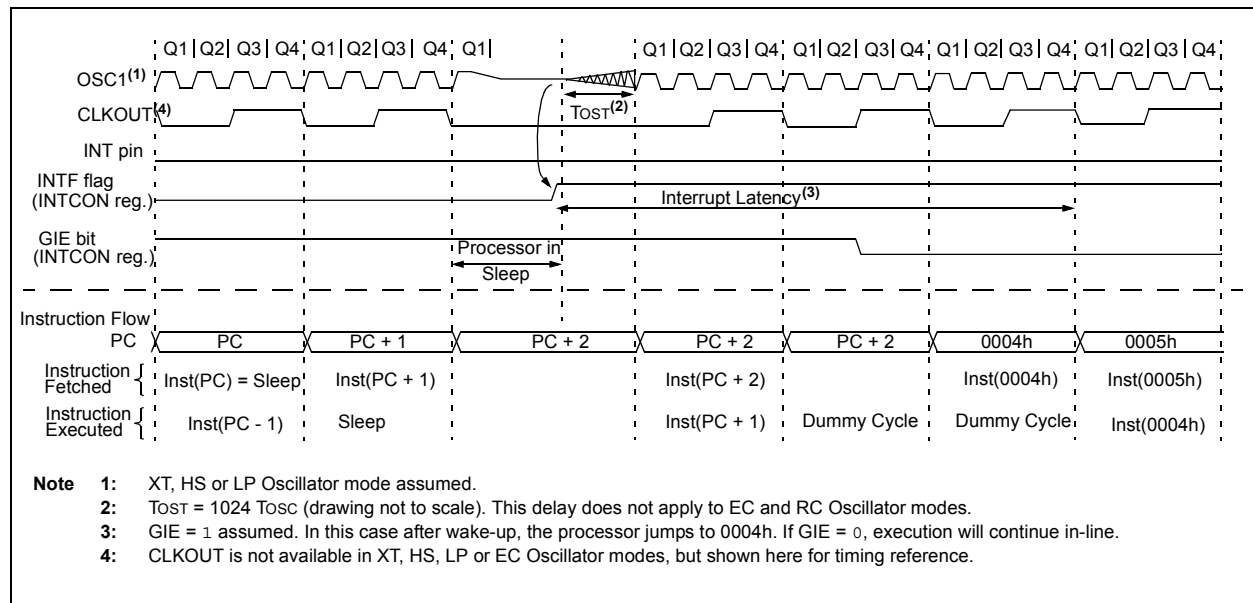
For additional information on how a module generates an interrupt, refer to the respective peripheral section.

Note: The ANSEL and CMCON0 registers must be initialized to configure an analog channel as a digital input. Pins configured as analog inputs will read '0'. Also, if a LCD output function is active on an external interrupt pin, that interrupt function will be disabled.

Even if the flag bits were checked before executing a `SLEEP` instruction, it may be possible for flag bits to become set before the `SLEEP` instruction completes. To determine whether a `SLEEP` instruction executed, test the `PD` bit. If the `PD` bit is set, the `SLEEP` instruction was executed as a `NOP`.

To ensure that the WDT is cleared, a `CLRWDT` instruction should be executed before a `SLEEP` instruction.

FIGURE 16-10: WAKE-UP FROM SLEEP THROUGH INTERRUPT



PIC16F913/914/916/917/946

FIGURE 19-8: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

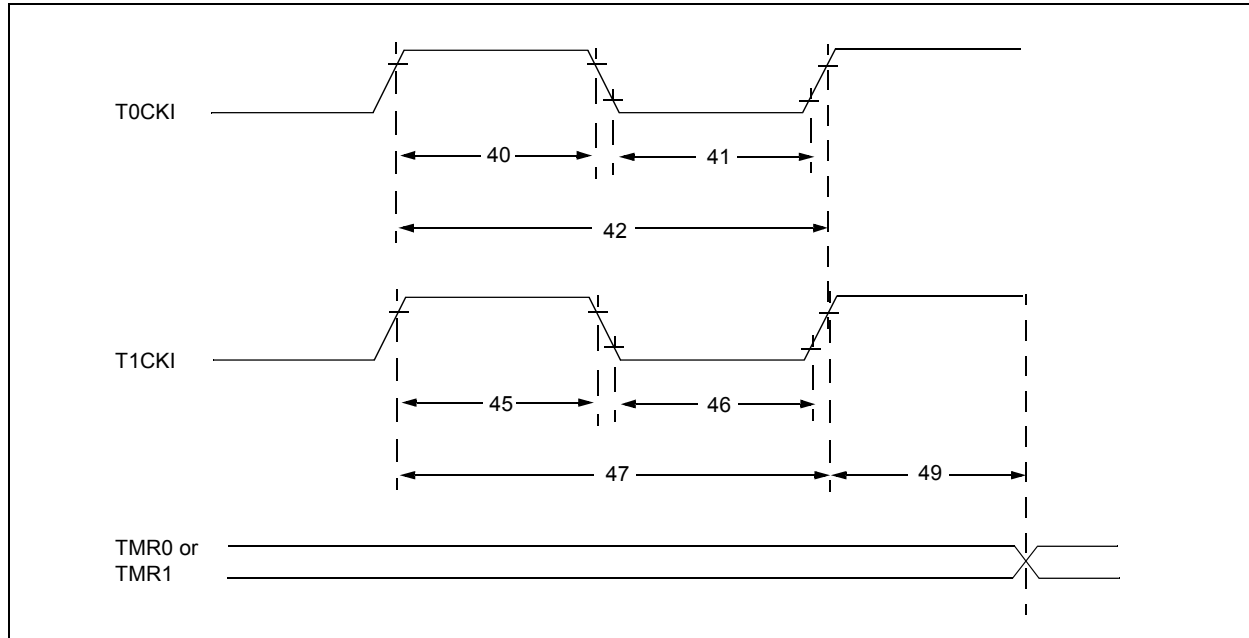


TABLE 19-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)								
Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$								
Param No.	Symbol	Characteristic		Min.	Typ†	Max.	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		Greater of: 20 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value (2, 4, ..., 256)
45*	Tt1H	T1CKI High Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
47*	Tt1P	T1CKI Input Period	Synchronous	Greater of: 30 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous	60	—	—	ns	
48	Ft1	Timer1 Oscillator Input Frequency Range (oscillator enabled by setting bit T1OSCEN)		—	32.768	—	kHz	
49*	TCKEZTMR1	Delay from External Clock Edge to Timer Increment		$2 T_{osc}$	—	$7 T_{osc}$	—	Timers in Sync mode

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16F913/914/916/917/946

TABLE 19-8: PIC16F913/914/916/917/946 A/D CONVERTER (ADC) CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD01	NR	Resolution	—	—	10 bits	bit	
AD02	EIL	Integral Error	—	—	± 1	LSb	$V_{\text{REF}} = 5.12\text{V}$
AD03	EDL	Differential Error	—	—	± 1	LSb	No missing codes to 10 bits $V_{\text{REF}} = 5.12\text{V}$
AD04	EOFF	Offset Error	—	—	± 1	LSb	$V_{\text{REF}} = 5.12\text{V}$
AD07	EGN	Gain Error	—	—	± 1	LSb	$V_{\text{REF}} = 5.12\text{V}$
AD06 AD06A	V_{REF}	Reference Voltage ⁽¹⁾	2.2 2.7	—	V_{DD} V_{DD}	V	Absolute minimum to ensure 1 LSb accuracy
AD07	V_{AIN}	Full-Scale Range	V_{SS}	—	V_{REF}	V	
AD08	Z_{AIN}	Recommended Impedance of Analog Voltage Source	—	—	10	$\text{k}\Omega$	
AD09*	I_{REF}	V_{REF} Input Current ⁽¹⁾	10	—	1000	μA	During V_{AIN} acquisition. Based on differential of V_{HOLD} to V_{AIN} .
			—	—	50	μA	During A/D conversion cycle.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: ADC V_{REF} is from external V_{REF} or V_{DD} pin, whichever is selected as reference input.

FIGURE 20-16: BOR IPD vs. VDD OVER TEMPERATURE

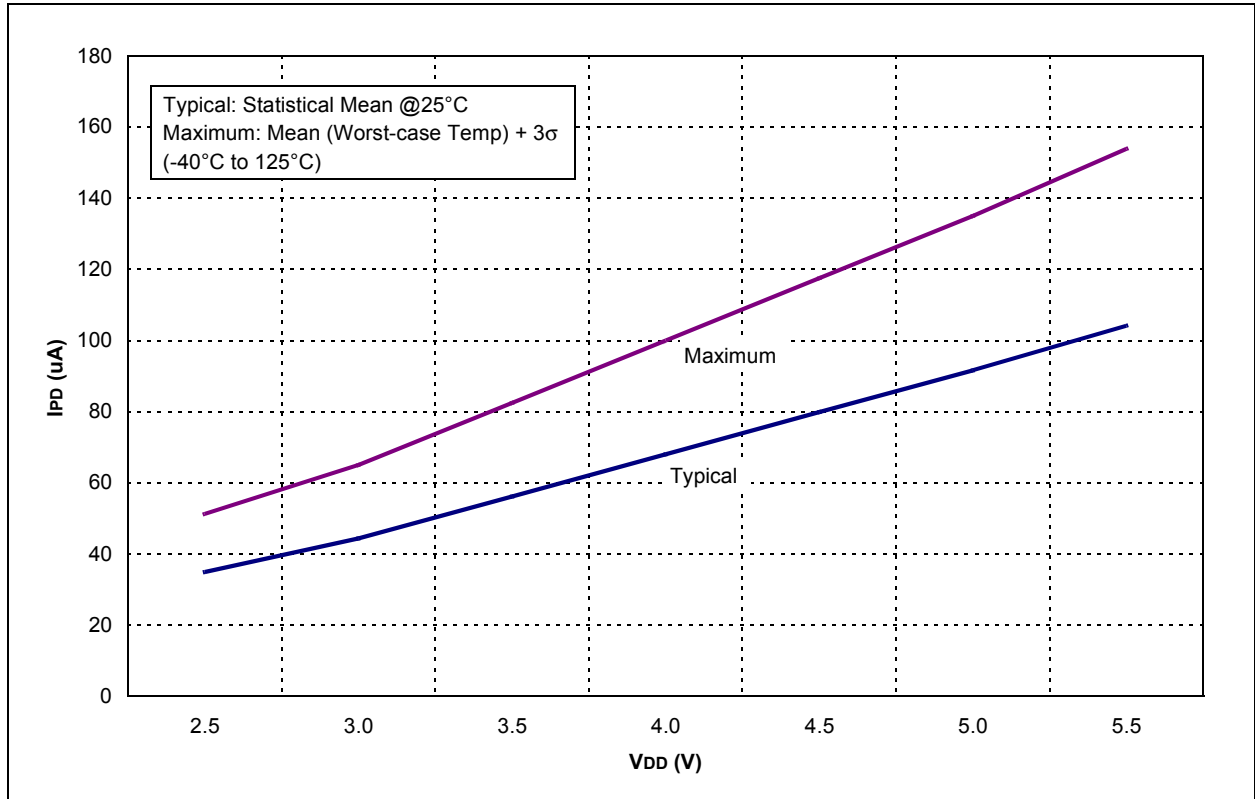
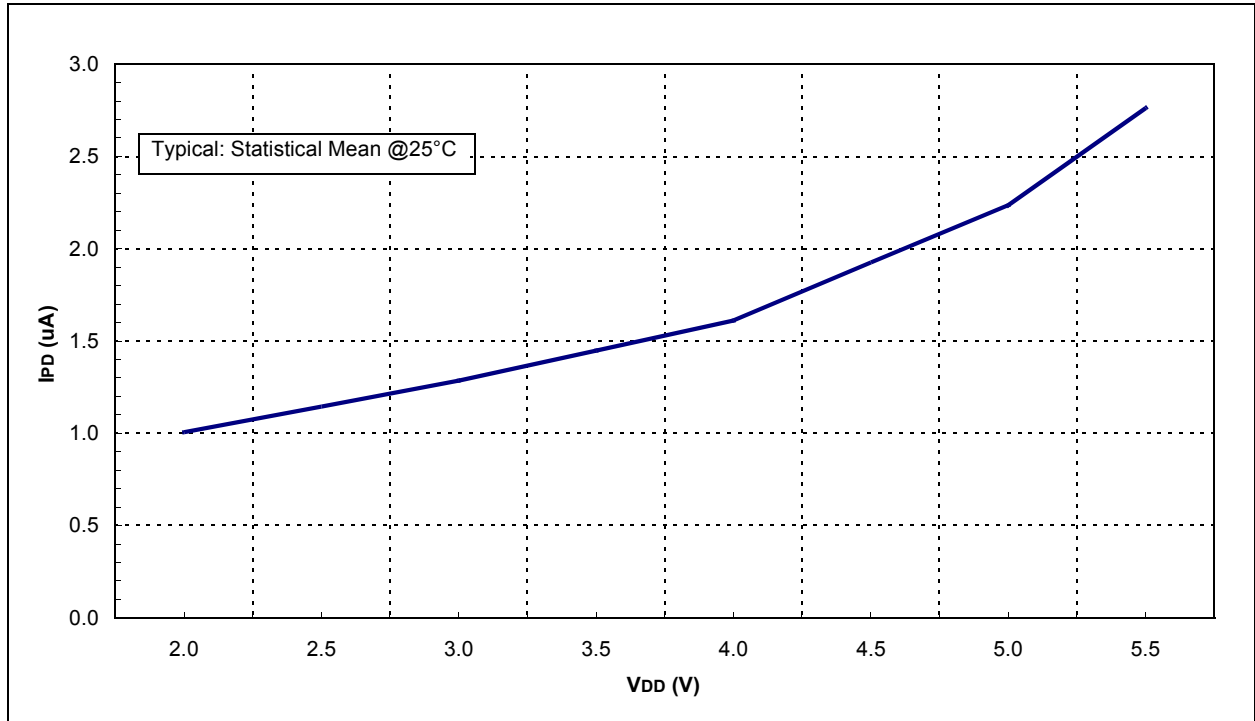


FIGURE 20-17: TYPICAL WDT IPD vs. VDD (25°C)



PIC16F913/914/916/917/946

FIGURE 20-24: T1OSC IPD vs. VDD OVER TEMPERATURE (32 kHz)

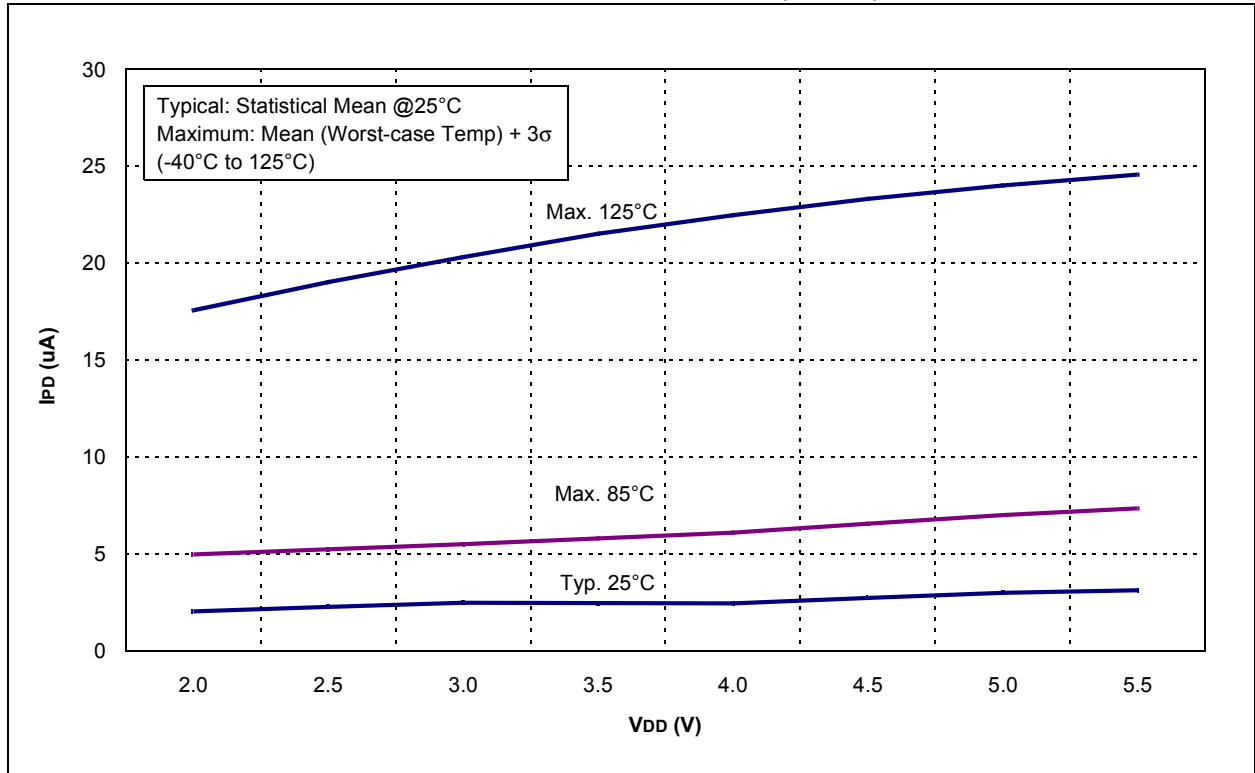


FIGURE 20-25: VOL vs. IOL OVER TEMPERATURE (VDD = 3.0V)

